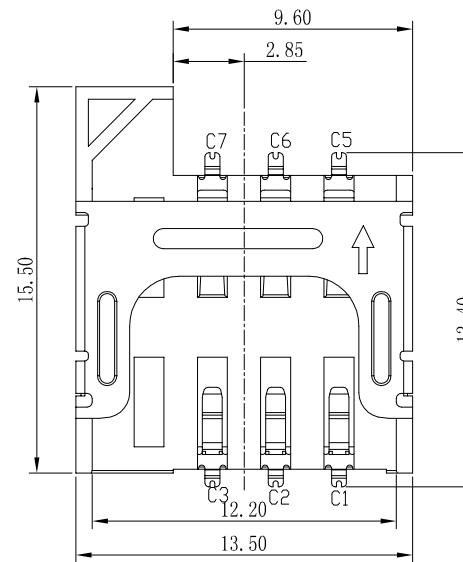
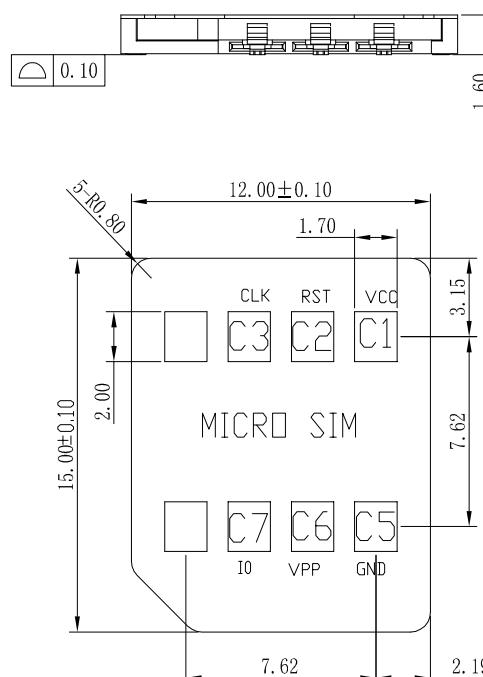


REV.	ECN.NO.	MODIFY.CONTENT	DATE
A		NEW	2014/04/29



SIM Card Pin Assignment

Pin No.	Name
C1	Vcc
C2	RST
C3	CLK
C4	Rrsvred
C5	GND
C6	Vpp
C7	I/O
C8	Reserved



NOTES:

1. MATERIAL:

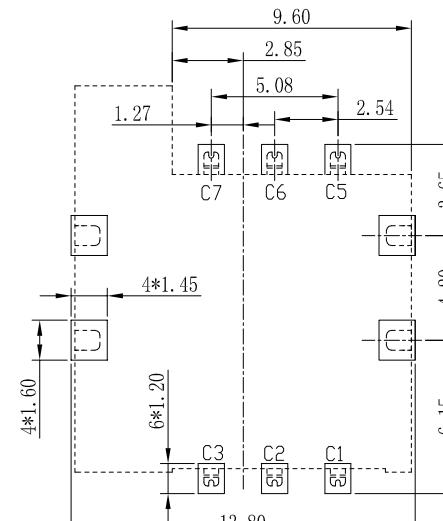
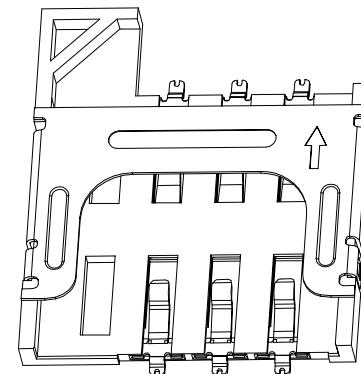
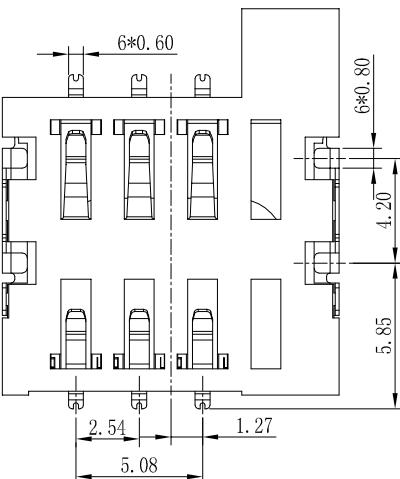
- 1). HOUSING MATERIAL:THERMOPLASTIC UL94V-0;COLOR:BLACK
- 2). CONTACT MATERIAL:COPPER ALLOY, T=0.15mm
- 3). SHELL MATERIAL:STAINLESS STEEL, T=0.15mm

2. FINISH:

- 1). CONTACT FINISH:50μ" MIN. NICKEL UNDER PLATED, PLATED 1μ" Au ON CONTACT AREA .PLATED GOLD FLASH ON SOLDER AREA.
- 2). SHELL FINISH:50μ" MIN. NICKEL UNDER PLATED, PLATED GOLD FLASH ON SOLDER AREA.

3. ELECTRICAL SPECIFICATIONS:

- 1). VOLTAGE RATING:12 VAC
- 2). CURRENT: 1 AMPERES MAX. PER CONTACT
- 3). OPERATION TEMPERATURE RANGE: -25°C ~ +70°C
- 4). CONTACT RESISTANCE:60mΩ MAX.
- 5). DIELECTRIC RESISTANCE: 1000MΩ MIN.
- 6). DIELECTRIC WITHSTANDING VOLTAGE:500V AC FOR 1 MINUTE
- 7). MAX. PROCESSING TEMP:260°C for 30 SECONDS



GENERAL TOLERANCE		DWG NO.	APPD:	WIND	Scale	1:1
X.±0.45	x.±5°	Title	1.5H MICRO SIM CARD 6P 单边带挡	CHKD:		UNIT
.X±0.35	.x.±2°			DR:		mm
.XX±0.25	.xx.±1°	Part NO.	5001B-SIM150-132	Date	2014/04/29	
.XXX±0.15	.xxx.±0.5°					
SHEET	1/1					

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